N-Ch 30V Fast Switching MOSFET

V_{DS}=30V, I_D=1.0A, $RDS_{(ON)}$=430mΩ

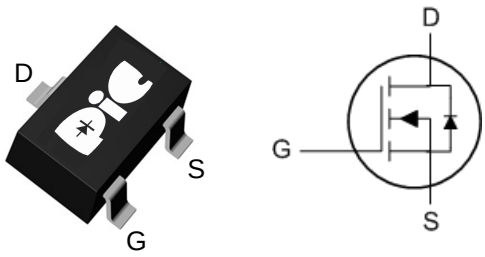
➢ General Description

This PAN3306R N-Channel enhancement mode power field effect transistor is the high density trench technology and this advanced technology can provide excellent Rds(On) performance and efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

➢ Feature

- ●Super high density cell design for extremely low RDS (ON)
- ●Exceptional on-resistance and maximum DC current capability
- ●SOT-323 package design

➢ SOT-323



➢ Application

- ●Net Working System
- ●Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- ●Battery Operated Systems
- ●Power Supply Converter Circuits
- ●Load/Power Switching Smart Phones, Pagers

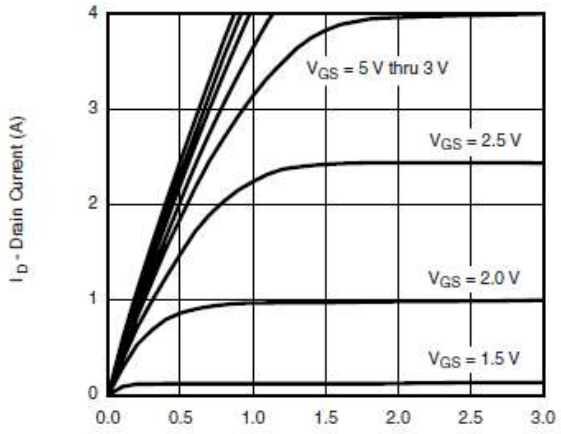
➢ Absolute Maximum Ratings

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DSS}	30	V
Gate –Source Voltage		V_{GSS}	±12	V
Continuous Drain Current(T_J=150℃)	T_A=25℃	I_D	1.0	A
	T_A=70℃		0.6	
Pulsed Drain Current		I_{DM}	6	A
Continuous Source Current(Diode Conduction)		I_S	1	A
Power Dissipation	T_A=25℃	P_D	0.35	W
	T_A=70℃		0.22	
Operating Junction Temperature		T_J	150	℃
Storage Temperature Range		T_{STG}	-55/150	℃
Thermal Resistance-Junction to Ambient		$R_{\theta JA}$	120	℃ /W

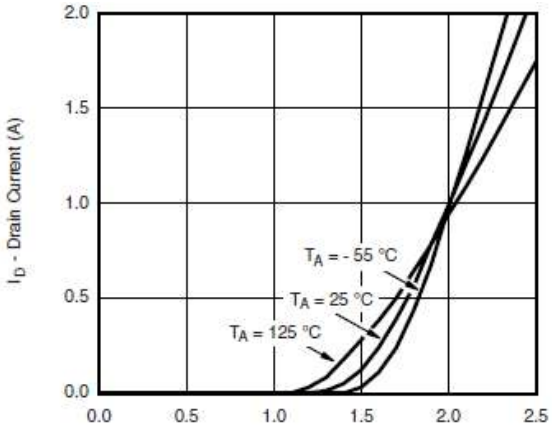
➢ Electrical Characteristics (T_A=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V,I_D=250uA	30			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=250uA	0.5		1.0	
Gate Leakage Current	I_{GSS}	V_{DS}=0V,V_{GS}=±12V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=24V,V_{GS}=0V			1	uA
		V_{DS}=24V,V_{GS}=0V T_J=85℃			5	
On-State Drain Current	$I_{D(on)}$	V_{DS}≧ 5V,V_{GS}=4.5V	1.8			A
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS}=4.5V,I_D=1.5A		380	430	mΩ
		V_{GS}=2.5V,I_D=1.2A		500	580	
		V_{GS}=1.8V,I_D=0.6A		760	860	
Forward Transconductance	g_{FS}	V_{DS}=10V,I_D=1.0A		1		S
Diode Forward Voltage	V_{SD}	I_S=1.0A,V_{GS}=0V		0.65	1.2	V
Dynamic						
Input Capacitance	C_{iss}	V_{DS}=15V,V_{GS}=0V f=1MHz		85		pF
Output Capacitance	C_{oss}			25		
Reverse Transfer Capacitance	C_{rss}			15		
Total Gate Charge	Q_g	V_{DS}=15V,V_{GS}=4.5V I_D≡1.2A		1.4	1.8	nC
Gate-Source Charge	Q_{gs}			0.3		
Gate-Drain Charge	Q_{gd}			0.6		
Turn-On Time	$t_{d(on)}$	V_{DD}=15V,R_L=20Ω I_D≡1.2A,V_{GEN}=4.5V R_G=1Ω		15	25	ns
	t_r			25	45	
Turn-Off Time	$t_{d(off)}$			15	25	
	t_f			10	20	

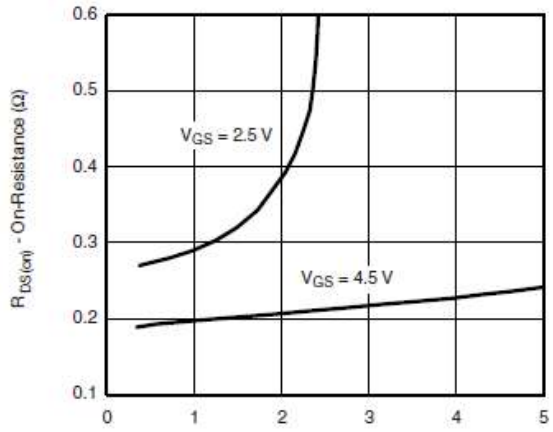
➢ Typical Characteristics



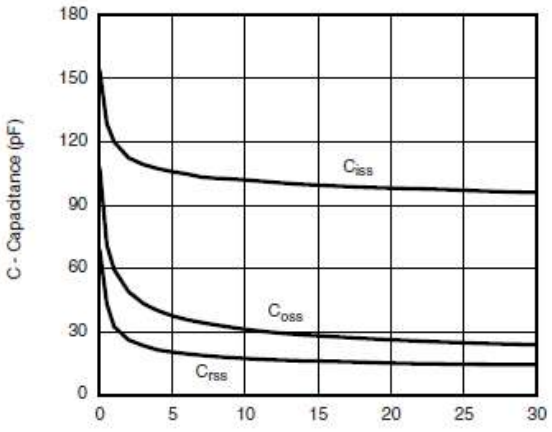
Output Characteristics



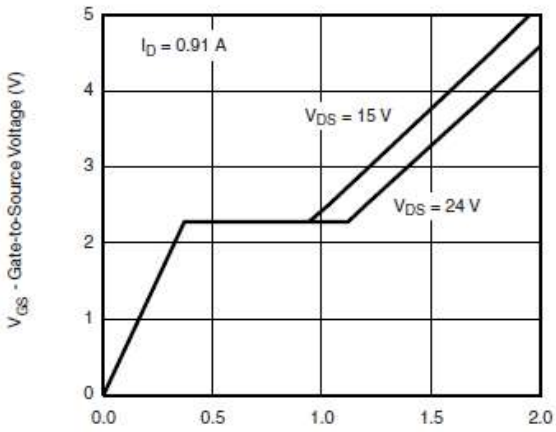
Transfer Characteristics Curves vs. Temperature



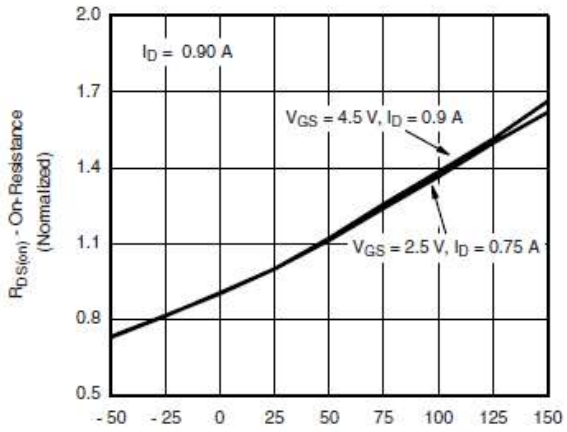
On-Resistance vs. Drain Current



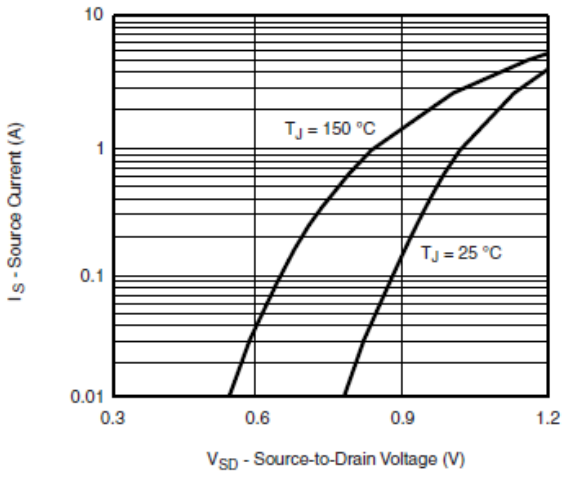
Capacitance



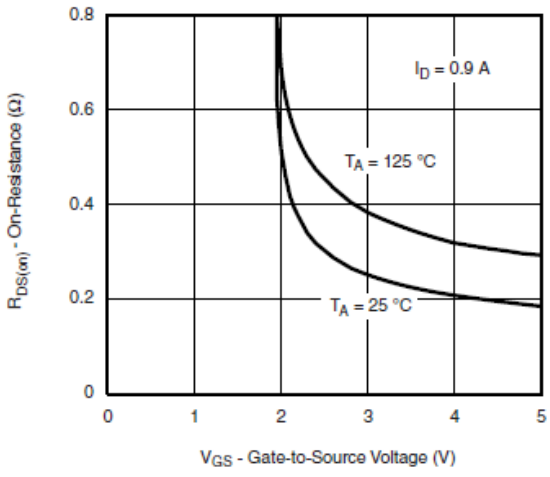
Gate Charge



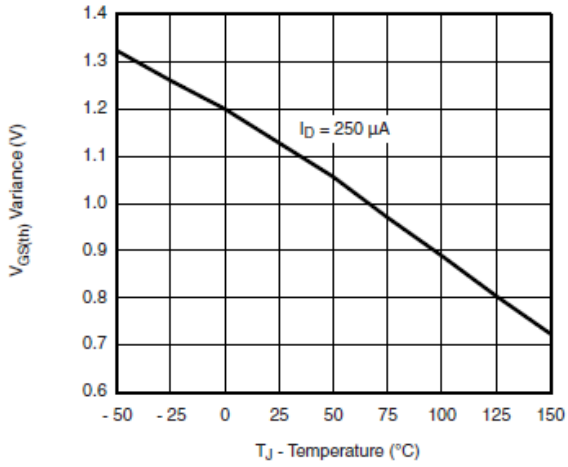
On-Resistance vs. Junction Temperature



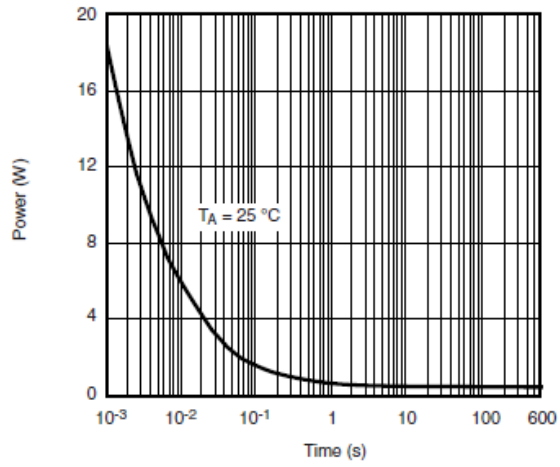
Forward Diode Voltage vs. Temperature



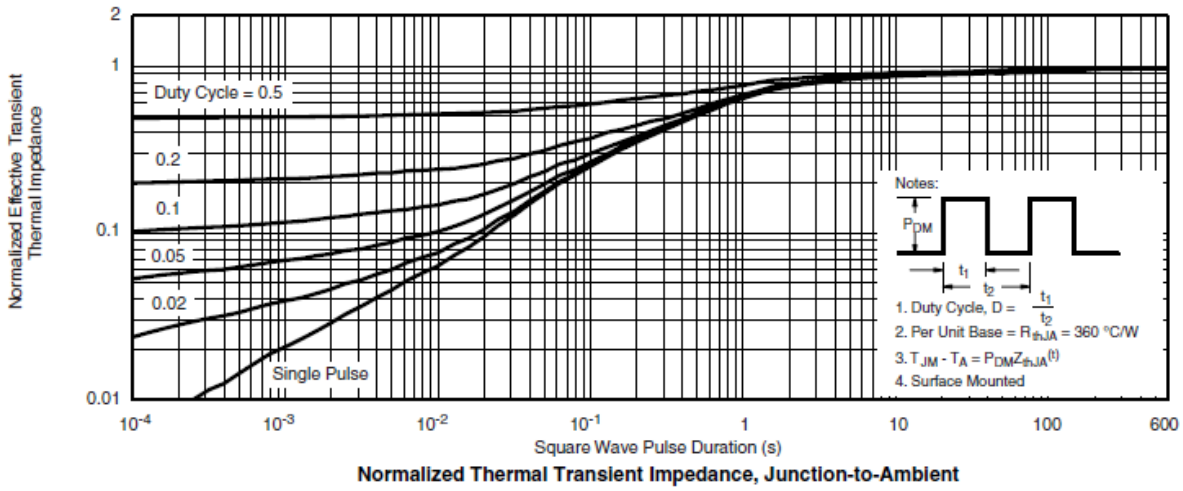
$R_{DS(on)}$ vs. V_{GS} vs. Temperature



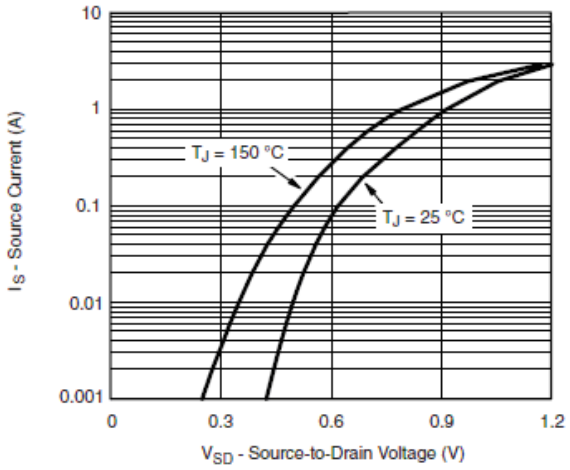
Threshold Voltage



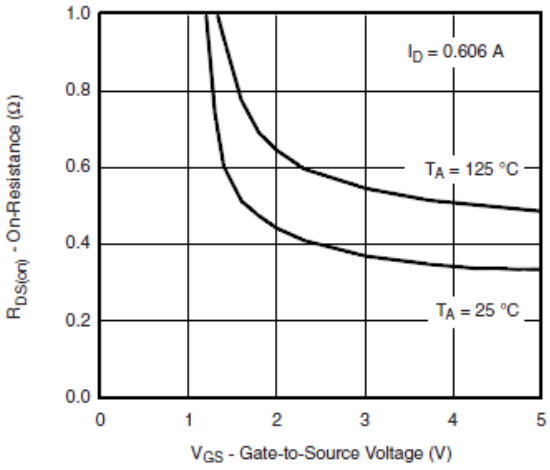
Single Pulse Power, Junction-to-Ambient



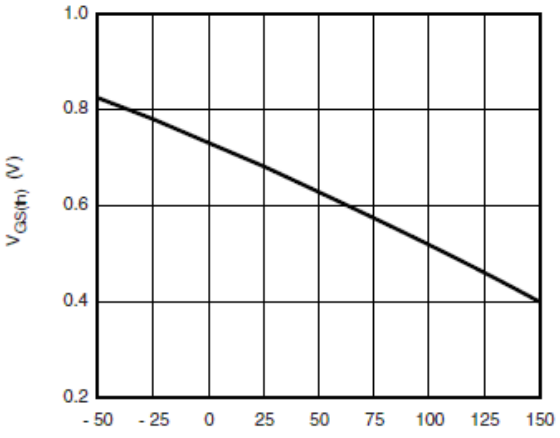
Normalized Thermal Transient Impedance, Junction-to-Ambient



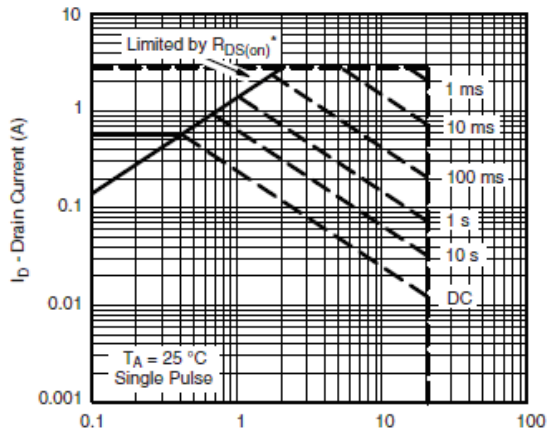
Source-Drain Diode Forward Voltage



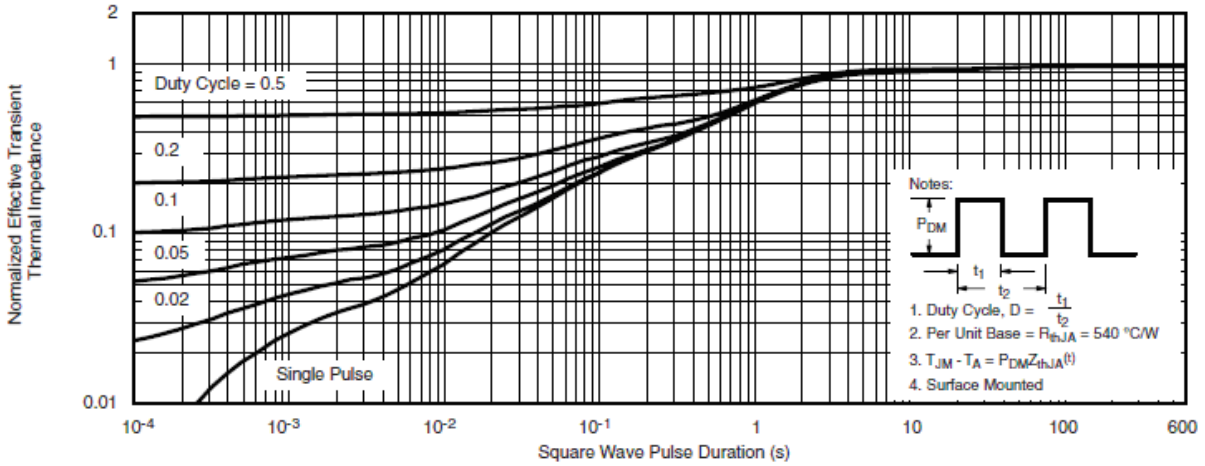
$R_{DS(on)}$ vs. V_{GS} vs Temperature



Threshold Voltage

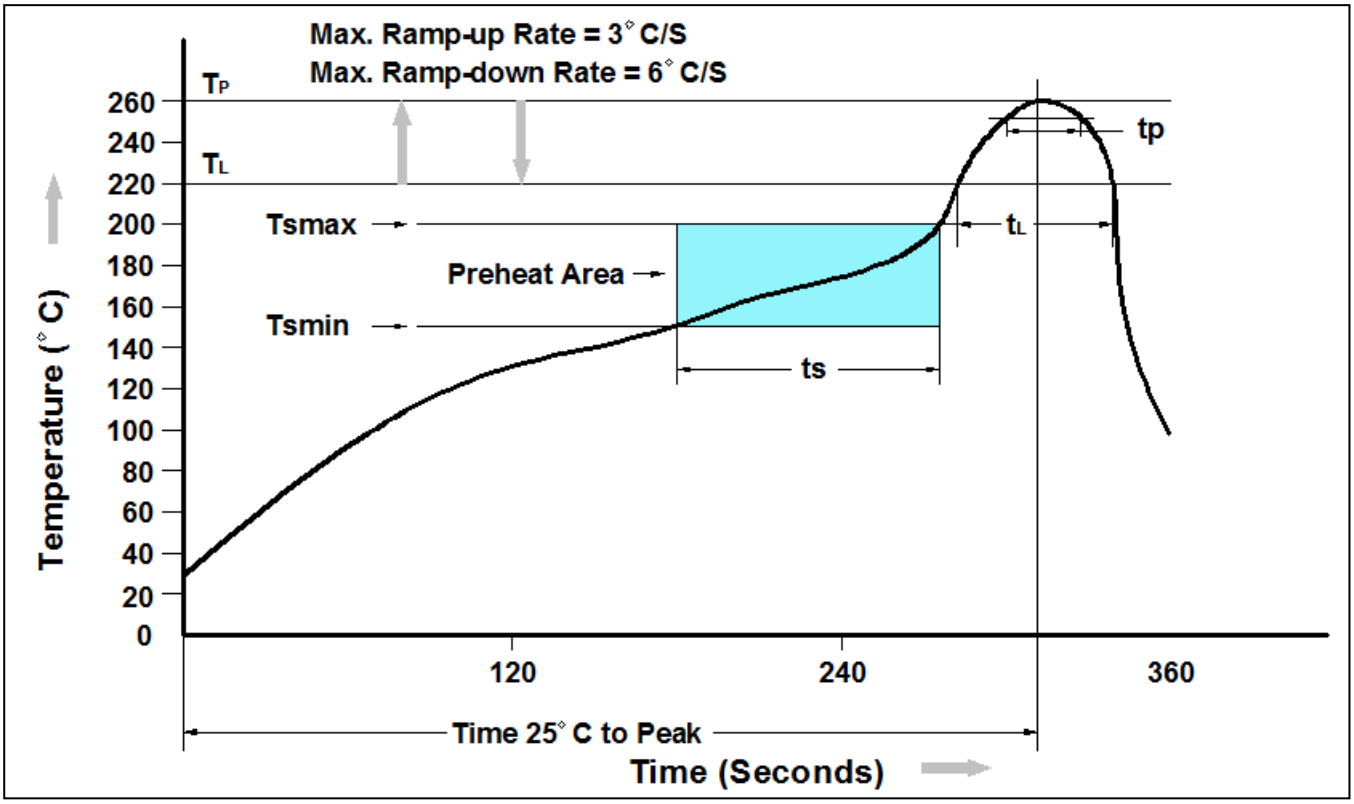


Safe Operating Area, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient

➢ Recommand IR Reflow Soldering Thermal Profile

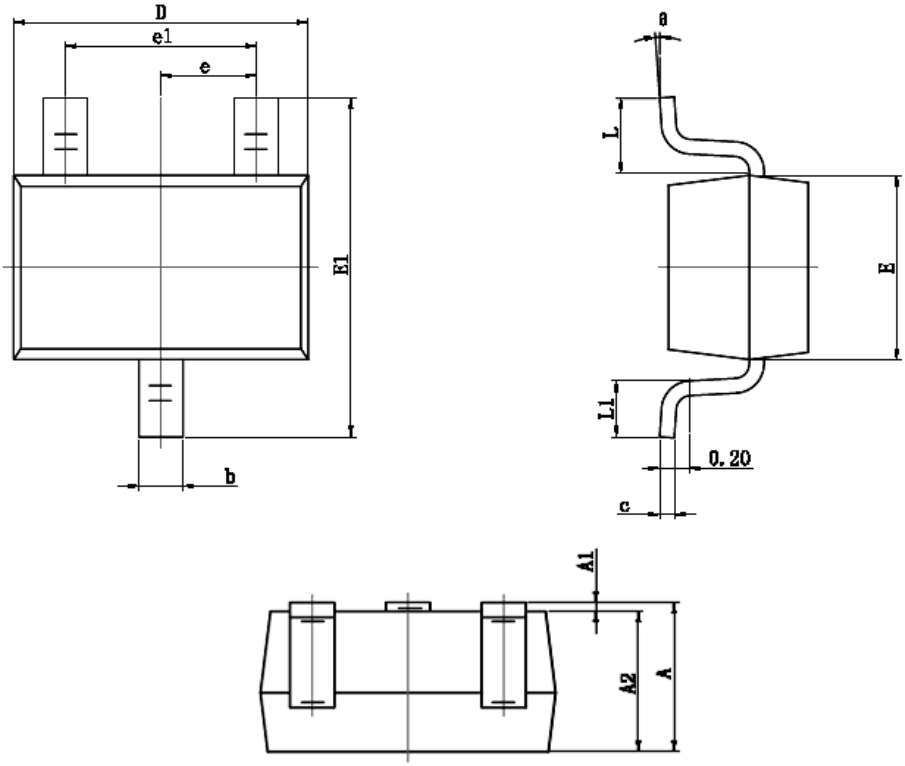


Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Average Ramp-up Rate (tL to tP)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (tP) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

➢ Ordering Information

Part Number	Description	Quantity
PAN3306R	SOT-323 Reel	3000 pcs

➢ Package Information (SOT-323)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP		0.026 TYP	
e1	1.200	1.400	0.047	0.055
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

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